

# Preliminary Technical Information

# TrenchT2<sup>™</sup> Power MOSFET

# IXTA170N075T2 IXTP170N075T2

N-Channel Enhancement Mode Avalanche Rated

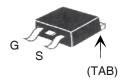


Symbol	Test Conditions	Maximum Ratings		
V <sub>DSS</sub>	T <sub>.</sub> = 25°C to 175°C	75	V	
V <sub>DGR</sub>	$T_J = 25^{\circ}\text{C to } 175^{\circ}\text{C}, R_{gs} = 1\text{M}\Omega$	75	V	
V <sub>GSM</sub>	Transient	± 20	V	
I <sub>D25</sub>	T <sub>C</sub> = 25°C	170	A	
LRMS	Lead Current Limit, RMS	75	Α	
I <sub>DM</sub>	$T_{_{\rm C}}$ = 25°C, pulse width limited by $T_{_{\rm JM}}$	510	Α	
I <sub>AR</sub>	T <sub>C</sub> = 25°C	85	А	
<b>E</b> <sub>AS</sub>	$T_{c} = 25^{\circ}C$	600	mJ	
P <sub>D</sub>	T <sub>C</sub> = 25°C	360	W	
T <sub>J</sub>		-55 +175	°C	
T <sub>JM</sub>		175	°C	
T <sub>stg</sub>		-55 +175	°C	
T,	1.6mm (0.062in.) from case for 10s	300	°C	
T <sub>sold</sub>	Plastic body for 10 seconds	260	°C	
M <sub>d</sub>	Mounting torque (TO-220)	1.13 / 10	Nm/lb.in.	
Weight	TO-263 TO-220	2.5 3.0	g g	

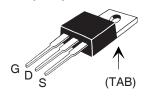
Symbol	Test Conditions	Cha	<b>Characteristic Values</b>		
(T <sub>J</sub> = 25°C unless otherwise specified)		Min.	Тур.	Max.	
BV <sub>DSS</sub>	$V_{GS} = 0V$ , $I_D = 250\mu A$	75			V
$V_{\rm GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	2.0		4.0	V
I <sub>GSS</sub>	$V_{GS} = \pm 20V, V_{DS} = 0V$			±200	nA
I <sub>DSS</sub>	$V_{DS} = V_{DSS}$			5	μΑ
	$V_{GS} = 0V$ $T_{J} = 15$	50°C		100	μΑ
R <sub>DS(on)</sub>	$V_{GS} = 10V, I_{D} = 50A, Notes 1, 2$			5.4	mΩ

 $V_{DSS} = 75V$   $I_{D25} = 170A$   $R_{DS(on)} \le 5.4m\Omega$ 

TO-263 (IXTA)



TO-220 (IXTP)



G = Gate S = Source D = Drain TAB = Drain

#### **Features**

- International standard packages
- Unclamped Inductive Switching (UIS) rated
- Low package inductance
- 175°C Operating Temperature
- High current handling capability
- ROHS Compliant
- High performance Trench
   Technology for extremely low R<sub>DS(on)</sub>

## Advantages

- Easy to mount
- Space savings
- High power density
- Synchronous

### **Applications**

- Synchronous Buck Converters
- High Current Switching Power Supplies
- Battery Powered Electric Motors
- Resonant-mode power supplies
- Electronics Ballast Application
- Class D Audio Amplifiers



Symbol		Test Conditions		Characteristic Values		
$(T_{J} = 2)$	5°C, ι	unless otherwise specified)	Min.	Тур.	Max.	
$g_{fs}$		$V_{DS} = 10V, I_{D} = 60A, \text{ Note 1}$	40	70	S	
C <sub>iss</sub>	)	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		6860	pF	
$C_{oss}$	}			810	pF	
C <sub>rss</sub>	J			148	pF	
t <sub>d(on)</sub>	)	Resistive Switching Times		19	ns	
t <sub>r</sub>		$V_{GS} = 10V$ , $V_{DS} = 0.5 \cdot V_{DSS}$ , $I_{D} = 0.5 \cdot I_{D25}$		11	ns	
t <sub>d(off)</sub>		$R_{G} = 3.3\Omega$ (External)		25	ns	
t <sub>f</sub>	)			19	ns	
$\mathbf{Q}_{g(on)}$	)			109	nC	
$Q_{gs}$	$V_{GS} =$	$V_{GS} = 10V$ , $V_{DS} = 0.5 \cdot V_{DSS}$ , $I_{D} = 0.5 \cdot I_{D25}$		37	nC	
$\mathbf{Q}_{gd}$				25	nC	
R <sub>thJC</sub>					0.42 °C/W	
R <sub>thCH</sub>		TO-220		0.50	°C/W	

#### Source-Drain Diode

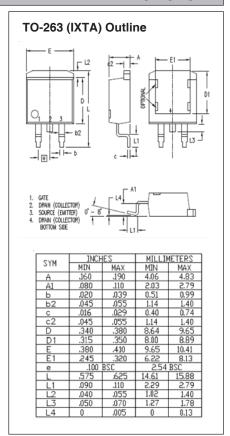
Symbol	Test Conditions (	hara	racteristic Values			
$(T_J = 25^{\circ}C, t)$	unless otherwise specified)	lin.	Тур.	Max.		
I <sub>s</sub>	$V_{GS} = 0V$			170	Α	
I <sub>SM</sub>	Repetitive, Pulse width limited by $\rm T_{\rm JM}$			680	Α	
V <sub>SD</sub>	$I_F = 50A, V_{GS} = 0V, \text{ Note 1}$			1.0	V	
t <sub>rr</sub>	$I_{\rm F} = 85 {\rm A}, \ V_{\rm GS} = 0 {\rm V}$		63		ns	
I <sub>RM</sub>	$-di/dt = 100A/\mu s$		4.8		Α	
Q <sub>RM</sub>	$V_R = 37V$		150		nC	

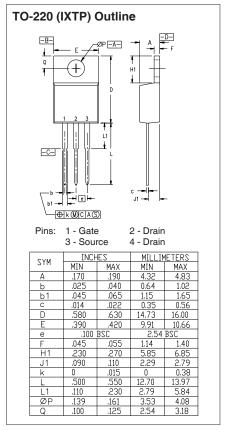
Notes: 1. Pulse test,  $t \le 300\mu s$ ; duty cycle,  $d \le 2\%$ .

2. On through-hole packages,  $R_{\mathrm{DS(on)}}$  Kelvin test contact location must be 5mm or less from the package body.

## PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from data gathered during objective characterizations of preliminary engineering lots; but also may yet contain some information supplied during a pre-production design evaluation. IXYS reserves the right to change limits, test conditions, and dimensions without notice.





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Fig. 1. Output Characteristics @ 25°C

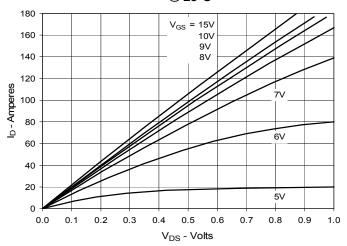


Fig. 3. Output Characteristics @ 150°C

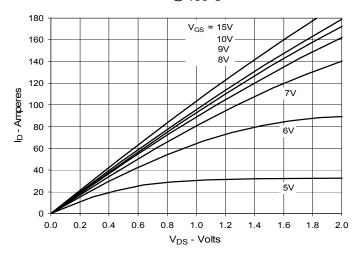


Fig. 5.  $R_{DS(on)}$  Normalized to  $I_D = 85A$  Value vs. Drain Current

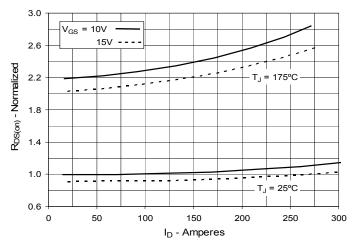


Fig. 2. Extended Output Characteristics @ 25°C

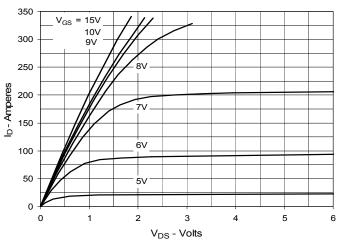


Fig. 4.  $R_{DS(on)}$  Normalized to  $I_D$  = 85A Value vs. Junction Temperature

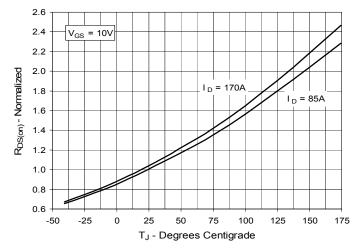
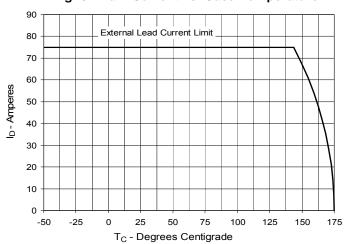


Fig. 6. Drain Current vs. Case Temperature





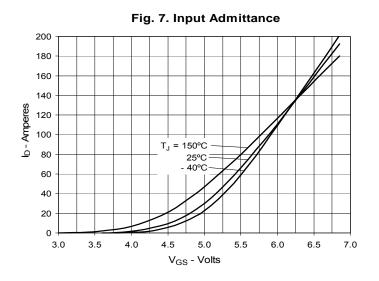
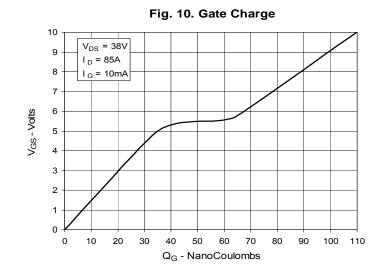
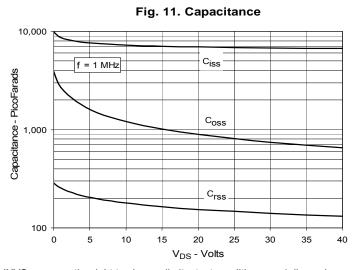
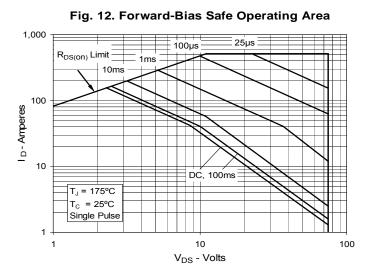


Fig. 8. Transconductance 110  $T_{,J} = -40^{\circ}C$ 100 90 80 25°C g<sub>fs</sub>-Siemens 70 150°C 60 50 40 30 20 10 20 40 60 100 120 160 200 0 80 140 180  $I_D$  - Amperes

Fig. 9. Forward Voltage Drop of **Intrinsic Diode** 280 240 200 ls - Amperes 160 120 T<sub>J</sub> = 150°C 80  $T_{,J} = 25^{\circ}C$ 40 0 0.4 0.5 0.6 0.7 0.8 0.9 1.0 1.1 1.2 1.3 V<sub>SD</sub> - Volts







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Fig. 13. Resistive Turn-on Rise Time vs. Junction Temperature

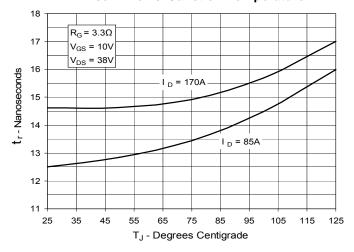


Fig. 15. Resistive Turn-on Switching Times vs. Gate Resistance

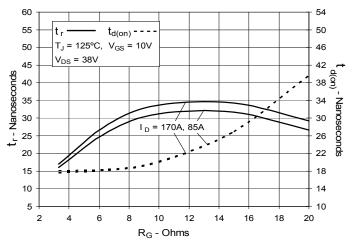


Fig. 17. Resistive Turn-off Switching Times vs. Drain Current

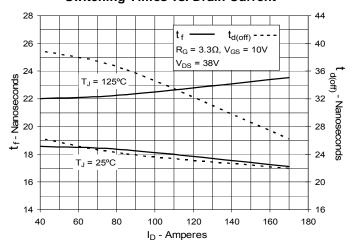


Fig. 14. Resistive Turn-on Rise Time vs. Drain Current

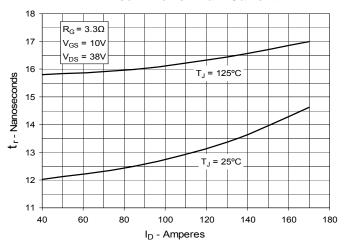


Fig. 16. Resistive Turn-off Switching Times vs. Junction Temperature

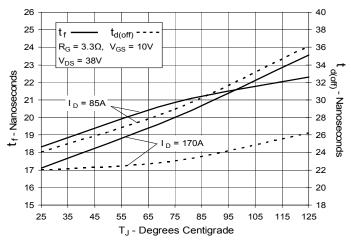
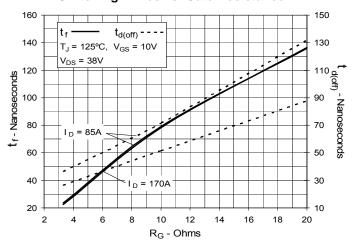


Fig. 18. Resistive Turn-off
Switching Times vs. Gate Resistance



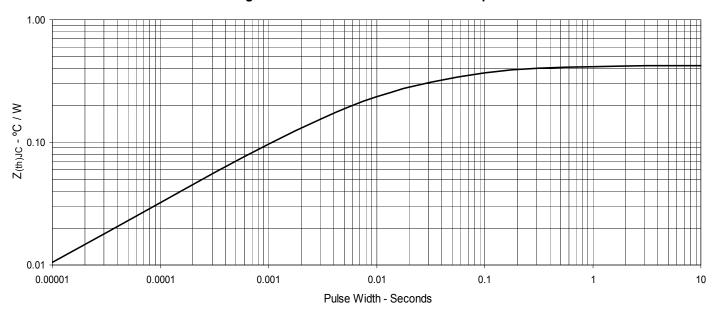


Fig. 19. Maximum Transient Thermal Impedance